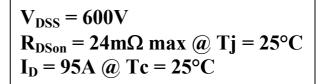
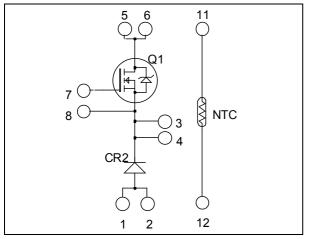
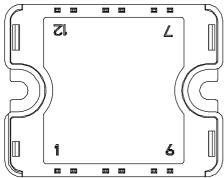


# Buck chopper Super Junction MOSFET Power Module







Pins 1/2; 3/4; 5/6 must be shorted together

### **Application**

- AC and DC motor control
- Switched Mode Power Supplies

#### **Features**

### · COOLMOS

#### Power Semiconductors

- Ultra low R<sub>DSon</sub>
- Low Miller capacitance
- Ultra low gate charge
- Avalanche energy rated
- Very rugged
- Very low stray inductance
- Internal thermistor for temperature monitoring
- High level of integration

#### **Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

### Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
$V_{ m DSS}$	Drain - Source Breakdown Voltage		600	V
т	(Continuous Drain Current	$T_c = 25$ °C	95	
$I_{D}$		$T_c = 80$ °C	70	A
$I_{DM}$	Pulsed Drain current		260	
$V_{GS}$	Gate - Source Voltage		±20	V
R <sub>DSon</sub>	Drain - Source ON Resistance		24	mΩ
$P_{D}$	Maximum Power Dissipation $T_c = 25^{\circ}C$		462	W
$I_{AR}$	Avalanche current (repetitive and non repetitive)		15	A
$E_{AR}$	Repetitive Avalanche Energy		3	- mJ
E <sub>AS</sub>	Single Pulse Avalanche Energy		1900	1113

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



## All ratings @ $T_j = 25^{\circ}C$ unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 600V$ $T_j = 25^{\circ}C$			350	^
		$V_{GS} = 0V, V_{DS} = 600V$ $T_j = 125^{\circ}C$			600	μΑ
R <sub>DS(on)</sub>	Drain – Source on Resistance	$V_{GS} = 10V, I_D = 47.5A$			24	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 5mA$	2.1	3	3.9	V
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			200	nA

**Dynamic Characteristics** 

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C <sub>iss</sub>	Input Capacitance	$V_{GS} = 0V ; V_{DS} = 25V$		14.4		nF
$C_{oss}$	Output Capacitance	f = 1MHz		17		111
$Q_{g}$	Total gate Charge	$V_{GS} = 10V$		300		
$Q_{\rm gs}$	Gate – Source Charge	$V_{Bus} = 300V$		68		nC
$Q_{\mathrm{gd}}$	Gate – Drain Charge	$I_D = 95A$		102		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C)		21		
$T_{\rm r}$	Rise Time	$V_{GS} = 10V$		30		ļ
$T_{d(off)}$	Turn-off Delay Time	$V_{\text{Bus}} = 400V$ $I_{\text{D}} = 95A$		100		ns
$T_{\mathrm{f}}$	Fall Time	$R_G = 2.5\Omega$		45		
Eon	Turn-on Switching Energy	Inductive switching @ 25°C $V_{GS} = 10V$ ; $V_{Bus} = 400V$		1350		μJ
$E_{\text{off}}$	Turn-off Switching Energy	$I_{D} = 95A ; R_{G} = 2.5\Omega$		1040		μυ
Eon	Turn-on Switching Energy	$\label{eq:local_continuity} \begin{array}{l} \textbf{Inductive switching @ 125°C} \\ V_{GS} = 10V \; ; \; V_{Bus} = 400V \\ I_D = 95A \; ; \; R_G = 2.5\Omega \end{array}$		2200		1
$E_{\text{off}}$	Turn-off Switching Energy			1270		μJ

Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage			600			V
$I_{RM}$	Maximum Reverse Leakage Current	V <sub>R</sub> =600V	$T_i = 25$ °C $T_i = 125$ °C			100 500	μΑ
$I_{\mathrm{F}}$	DC Forward Current		$Tc = 80^{\circ}C$		100		A
	Diode Forward Voltage	$I_F = 100A$			1.6	2	
$V_{\mathrm{F}}$		$I_F = 200A$			2		V
		$I_F = 100A$	$T_{i} = 125^{\circ}C$		1.3		
	Davianca Dagayany Tima		$T_j = 25$ °C		160		nc
$t_{rr}$	Reverse Recovery Time	$I_F = 100A$	$T_j = 125$ °C		220		ns
Q <sub>rr</sub>	Reverse Recovery Charge	$V_R = 400V$ $di/dt = 200A/\mu s$	$T_j = 25$ °C		290		пC
		$T_{j} = 125$	$T_{j} = 125^{\circ}C$		1530		пС



Thermal and package characteristics

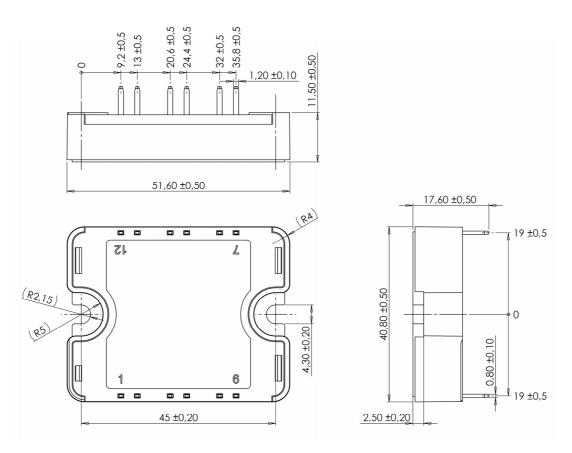
Symbol	Characteristic			Min	Тур	Max	Unit
$R_{\text{thJC}}$	Junction to Case Thermal Resistance	Transist	or			0.27	°C/W
	Junction to Case Thermal Resistance					0.55	C/W
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
$T_{J}$	Operating junction temperature range			-40		150	
$T_{STG}$	Storage Temperature Range			-40		125	°C
$T_{\rm C}$	Operating Case Temperature	-40		100			
Torque	Mounting torque	To heatsink	M4	2		3	N.m
Wt	Package Weight				80	g	

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic	Min	Typ	Max	Unit
R <sub>25</sub>	Resistance @ 25°C		50		kΩ
B 25/85	$T_{25} = 298.15 \text{ K}$		3952		K

$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature} \\ R_T: \text{ Thermistor value at T}$$

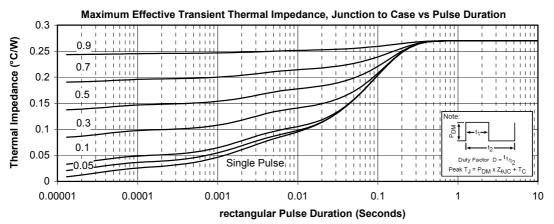
### SP1 Package outline (dimensions in mm)

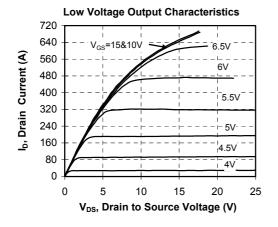


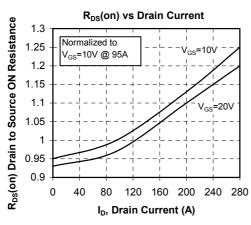
See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

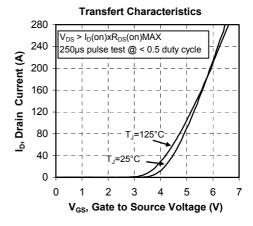


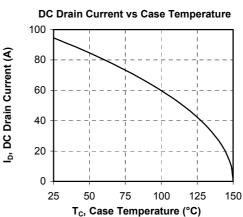
### **Typical Performance Curve**



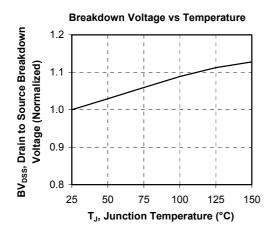


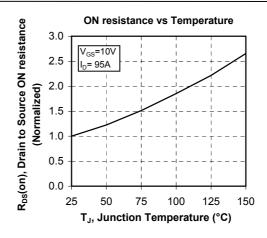


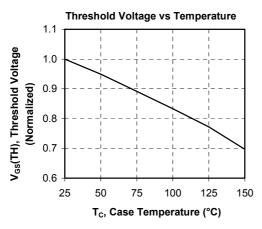


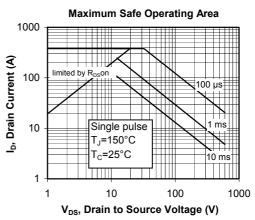


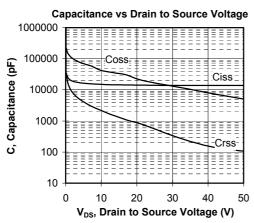


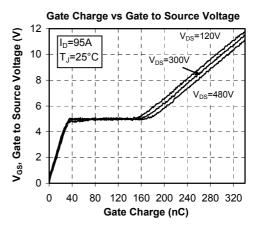




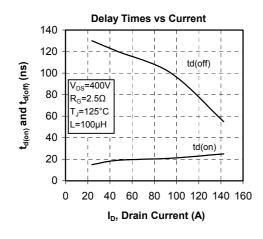


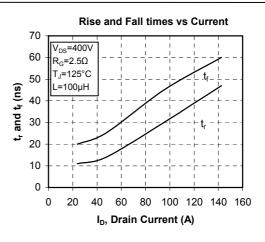


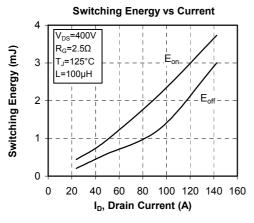


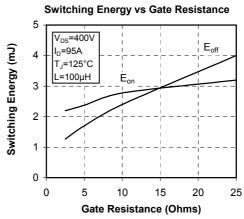


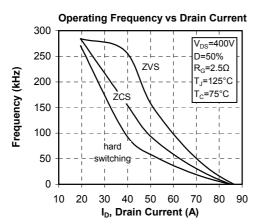


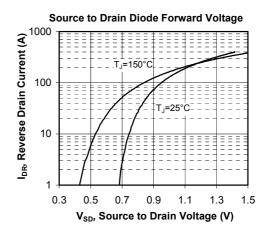












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